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With the principle of "Quality Parts,Customers Priority,Honest Operation, and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!


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LCB110 Single-Pole, Normally Closed OptoMOS ${ }^{\circledR}$ Relay

| Parameter | Ratings | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 350 | $\mathrm{~V}_{\mathrm{P}}$ |
| Load Current | 120 | $\mathrm{~mA}_{\mathrm{rms}} / \mathrm{mA}_{\mathrm{DC}}$ |
| On-Resistance (max) | 35 | $\Omega$ |

## Features

- $3750 \mathrm{~V}_{\text {rms }}$ Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- Arc-Free With No Snubbing Circuits
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Small 6-Pin Package
- Machine Insertable, Wave Solderable
- Surface Mount Tape \& Reel Version Available


## Applications

- Telecommunications
- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, Pocket Size)
- Hook Switch
- Dial Pulsing
- Ground Start
- Ringing Injection
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls


## Description

The LCB110 is a single-pole, normally closed (1-Form-B) relay that uses optically coupled MOSFET technology to provide $3750 \mathrm{~V}_{\text {rms }}$ of input to output isolation.

Its optically coupled outputs, which use the patented OptoMOS architecture, are controlled by a highly efficient GaAIAs infrared LED.

The LCB110 has low on-resistance and is well suited for most applications requiring a normally closed relay.

## Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component: TUV Certificate B 090749410006


## Ordering Information

| Part \# | Description |
| :--- | :--- |
| LCB110 | 6-Pin DIP (50/Tube) |
| LCB110S | 6-Pin Surface Mount (50/Tube) |
| LCB110STR | 6-Pin Surface Mount (1000/Reel) |

* For other packaging options consult factory.


## Pin Configuration



DC Only Configuration


Switching Characteristics of Normally Closed Devices


Absolute Maximum Ratings @ $25^{\circ} \mathrm{C}$

| Parameter | Ratings | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 350 | $\mathrm{~V}_{\mathrm{P}}$ |
| Reverse Input Voltage | 5 | V |
| Input Control Current <br> Peak (10ms) | 50 | mA |
|  | 1 | A |
| Input Power Dissipation ${ }^{1}$ | 150 | mW |
| Total Power Dissipation ${ }^{2}$ | 800 | mW |
| Isolation voltage, Input to Output | 3750 | $\mathrm{~V}_{\text {rms }}$ |
| Operational Temperature | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |

${ }^{1}$ Derate linearly $3.33 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$
${ }^{1}$ Derate linearly $6.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ $25^{\circ} \mathrm{C}$

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Characteristics |  |  |  |  |  |  |
| Load Current Continuous |  |  |  |  |  |  |
| DC Configuration |  | $\mathrm{I}_{\mathrm{L}}$ | - | - | 200 | $\mathrm{mas}_{\text {dC }}$ |
| Peak Load Current | $\mathrm{t}=10 \mathrm{~ms}$ | $\mathrm{I}_{\mathrm{L}}$ | - | - | $\pm 350$ | $m A_{p}$ |
| On-Resistance AC/DC Configuration | $\mathrm{I}_{\mathrm{L}}=120 \mathrm{~mA}$ | $\mathrm{R}_{\text {ON }}$ | - | 23 | 35 | $\Omega$ |
| DC Configuration | $\mathrm{I}_{\mathrm{L}}=200 \mathrm{~mA}$ |  | - | 7 | 10 |  |
| Off-State Leakage Current | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=350 \mathrm{~V}_{\mathrm{P}}$ | $\mathrm{I}_{\text {LEAK }}$ | - | - | 1 | $\mu \mathrm{A}$ |
| Switching Speeds Turn-On | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=10 \mathrm{~V}$ | $\mathrm{t}_{\text {on }}$ | - | 0.38 | 3 | ms |
| Turn-Off |  | $\mathrm{t}_{\text {off }}$ | - | 0.93 | 3 |  |
| Output Capacitance | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=50 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{\text {OUT }}$ | - | 25 | - | pF |
| Input Characteristics |  |  |  |  |  |  |
| Input Control Current to Activate | $\mathrm{I}_{\mathrm{L}}=120 \mathrm{~mA}$ | $\mathrm{I}_{\text {F }}$ | - | - | 5 | mA |
| Input Control Current to Deactivate | - | $I_{\text {F }}$ | 0.4 | 0.7 | - | mA |
| Input Voltage Drop | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | $V_{F}$ | 0.9 | 1.2 | 1.4 | V |
| Reverse Input Current | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ | $I_{\text {R }}$ | - | - | 10 | $\mu \mathrm{A}$ |
| Common Characteristics |  |  |  |  |  |  |
| Input to Output Capacitance | - | $\mathrm{C}_{10}$ | - | 3 | - | pF |

PERFORMANCE DATA @ $25^{\circ} \mathrm{C}$ (Unless Otherwise Noted)*

*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA @ $25^{\circ} \mathrm{C}$ (Unless Otherwise Noted)*


Typical Leakage vs. Temperature

Measured Across Pins 4\&6 $\left(I_{F}=5 \mathrm{~mA}, \mathrm{~V}_{\mathrm{L}}=350 \mathrm{~V}\right)$


Energy Rating Curve

*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

## Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) rating as shown below, and should be handled according to the requirements of the latest version of the joint industry standard IPC/JEDEC J-STD-033.

| Device | Moisture Sensitivity Level (MSL) Rating |
| :---: | :---: |
| LCB110 / LCB110S | MSL 1 |

## ESD Sensitivity

This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

## Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of J-STD-020 must be observed.

| Device | Maximum Temperature x Time |
| :---: | :---: |
| LCB110 / LCB110S | $250^{\circ} \mathrm{C}$ for 30 seconds |

## Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.


Integrated Circuits Division

MECHANICAL DIMENSIONS

## LCB110





$$
\frac{\text { Dimensions }}{m m}
$$

## LCB110S



PCB Land Pattern


$\underset{$| mm |
| :---: |
|  (inches)  |$}{\text { Dimensions }}$

## LCB110STR Tape \& Reel



NOTES:

1. All dimensions carry tolerances of EIA Standard 481-2
2. The tape complies with all "Notes" for constant dimensions listed on page 5 of EIA-481-2

For additional information please visit our website at: www.ixysic.com
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